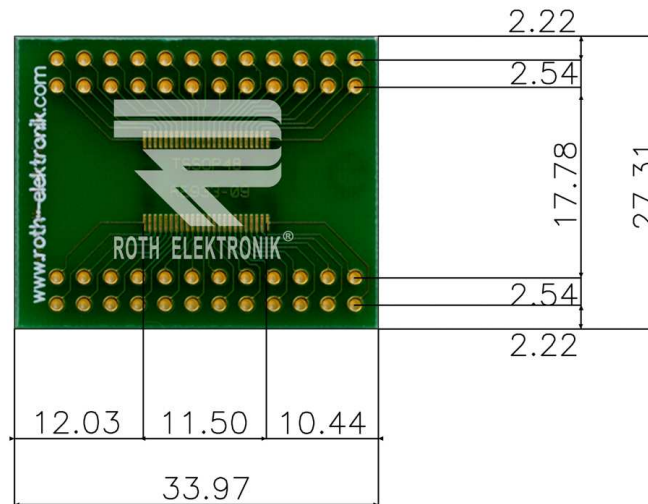




RE933-09

- Epoxy fibre-glass FR4 1.50 mm
- Double-sided 35 µm Cu
- Plated through holes (PTH)
- Surface chem. Ni/Au with solder stop mask
- Adaption circuit board for TSSOP 48
- Pitch: 0.50 mm (240 mil)
- Hole diameter 1.00 mm
- Size 27.31 x 33.97 mm

Module-No. Pitch mil Pin Size (mm)

RE933-09 0.500 mm 19.6 48 6.100 (240 mil)

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